

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Hideki MINATO	06/16/2010
Hideki KABUNE	06/17/2010
Atsushi FURUMOTO	06/16/2010
RECEIVING PARTY DATA	
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City:	KARIYA-CITY, AICHI-PREF.
State/Country:	JAPAN
Postal Code:	448-8661
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12822412
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ATTORNEY DOCKET NUMBER:	MNL-2018-2541
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Total Attachments: 1 source=2018-2541#page1.tif	

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Case No. : _____
127665-US-KK-ns

ASSIGNMENT OF U.S. PATENT APPLICATION

(Inventors) Hideki Minato
Hideki Kabune
Atsushi Furumoto

In consideration of the sum of one dollar (\$1.00) and other good and valuable considerations paid to each of the undersigned, the undersigned, agree(s) to assign, and hereby does assign, transfer and set over to

(Assignee) DENSO CORPORATION a corporation of Japan
(Address) 1-1, Showa-cho, Kariya-city, Aichi-pref., 448-8664 Japan

(Title) (hereinafter designated as the Assignee) the undersigned's entire right, title and interest for the United States, its territories, dependencies and possessions in the invention, and all applications for patent and any Letters Patent which may be granted therefore, known as LINKED SEMICONDUCTOR MODULE UNIT AND ELECTRONIC CIRCUIT- INTEGRATED MOTOR DEVICE USING SAME

for which the undersigned has (have) executed on even date herewith an application for patent in the United States of America or, if not on even date, then has executed on _____ or has already filed U.S. application Serial No. _____ on _____

The undersigned acknowledges an obligation of assignment of this invention to said assignee at the time the invention was made.

The undersigned agree(s) to execute all papers and documents necessary in connection with the application or any interference which may be declared and any continuing or divisional applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient and further to perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patent of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of NIXON & VANDERHYE P.C. the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document. It is understood and agreed that ASSIGNEE'S attorneys Nixon & Vanderhye P.C. have represented only ASSIGNEE and will continue to represent only ASSIGNEE with respect to this invention.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned signature(s):

Date June 16, 2010 Signature of Inventor Hideki Minato
Hideki Minato
Date June 17, 2010 Signature of Inventor Hideki Kabune
Hideki Kabune
Date June 16, 2010 Signature of Inventor Atsushi Furumoto
Atsushi Furumoto

Date H. M. June 16, 2010 Witnessed by: Hideki Minato Masami Hokoyama
~~June 16, 2010~~
Date June 16, 2010 Witnessed by: Masami Hokoyama

Date June 17, 2010 Witnessed by: Masami Hokoyama

Date June 16, 2010 Witnessed by: Masami Hokoyama

A. F. June 16, 2010

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